	© Co	terial Compo pyright 2005. IPC, Bannocl Iternational and Pan-Americ	kburn, Illinois	. All rights reserv	tion with lower	level pa	rts, the	declaratio	on encor		er level mate	erials for whic	if the item is an assembly th the manufacturer has nis declaration.	
1/32-2 1.1		Neb Site for Informat		-1752 Standa	rd		Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, Homogeneous M						rials and Mfg Informa	
Supplier Information														
Company Name *		Company Unique ID		Unique ID Au	Ithority	Respon	se Date	<b>e</b> *		Response Doc	ument ID			
SEMTECH CORPORATIO	00-847-9941		DUNS	2022-08-30										
Contact Name * Julie Vargo		Title - Contact Customer/Document		Phone - Con (805) 489-21	Email - Contact * jvargo@semtech.com				Duplicate Contact -> Authorized Representative					
Authorized Representative *         Title - Representative           Julie Vargo         Customer/Document Compared to the second s				Phone - Rep (805) 489-21	Email - Representative * jvargo@semtech.com				Supplier Comr	nents or URL	for Addition	al Information		
Requester Item Number	Requester Item Number N			Mfr Item Name	Effective	Date	Version Manufa		acturing Site	Weight *	UOM	Unit Type		
		RCLAMP0531T.TCT		Ultra-Low Ca				China		0.799	mg	Each		
Alternate Recommenda	Alternate Recommendation							Alternate Item Co		nments				
Manufacturing Proces	s Inf	formation												
Terminal Plating / Grid Array	Materi	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ating P	eak Proc	ess Body	Temper	ature Max Time	at Peak Tem	perature Num	ber of Reflow Cycles	
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy Comments			,	<b>260</b> C					<b>30</b> se	conds 3				
RCLAMP0531T.TCT is RI	EACH	I-compliant product	, per EU F	Regulation E	C1907/2006 to inc	lude the	e most r	ecent a	ddition	s to the SVHC	candidate I	ist of substa	ances - ckdm	

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cumption Fields					
RoHS Material Composition Declaration Declaration Declaration Type * Detailed												
		limit of 0.1% by mass (100 thers (PBDE) and quantity	, .				ominated Biphenyls (PBB),					
chromium, polybrominate excess of an applicable of gathered the information Company will rely on this completing this form, and certifications regarding the conditions of that agreen	ed biphenyls and/or polybrominated quantity limit, please indicate below it provides in this form using approp certification in determining the com I that Supplier may not have independent rein contributions to the part, and the nent, including any warranty rights a	which, if any, RoHS exemption you b priate methods to ensure its accuracy apliance of its products with European andently verified such information. Ho pose certifications are at least as comp	icted substance") in excess believe may apply. If the p y and that such information n Union member state laws bowever, in situations where prehensive as the certification that agreement, will be the s	of the applicable quantity limit bart is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independentl on in this paragraph. If the Co ole and exclusive source of the	identified above. If a homogene- evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges to y verified information provided by mpany and the Supplier enter into a Supplier's liability and the Comp	eous material within the part cont n shall encompass all such comp f the date that Supplier complete that Supplier may have relied on y others, Supplier agrees that, at to a written agreement with response upany's remedies for issues that a	tains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that					
RoHS Declaration	n * 1 - Item(s) does not contain	RoHS restricted substances per th	he definition above			Supplier Acceptance *	Accepted					
	declared item does not cont Il applicable exemptions.	ain RoHS restricted substanc	es per the definition a	bove except for defined	RoHS exemptions, then s	select the corresponding re	esponse in the RoHS Declaration					
Declaration Si	gnature											
		C 1 1 11 C (1 1 )			· • • • • •	<b>T</b> 1: 10 11 1 4	D' i ll i					

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

		Item/SubItem			Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of	Tolerance		PPM
	_	Name			Material	Weight	Measure		Level	Cubstance Category			oubstance		Exempt	Weight	Measure	-	+	
+	I -I	Chip	+M	-M	Silicon Die	0.0364	mg	+C -	Supplier		+S	-S	Silicon (Si)	7440-21-3		0.0364	mg			45,578
+	I -I	Lead Frame	+M	-M	C7025	0.35859	9mg	+C -	Supplier		+S	-S	Copper (Cu)	7440-50-8		0.3439	mg			430,23
											+S	-S	Silicon (Si)	7440-21-3		0.0026	mg			3,253
											+S	-S	Magnesium (Mg)	7439-95-4		0.0006	mg			785
								+C -	Св	Nickel (external applic	+S	-S	Nickel	7440-02-0		0.0115	mg			14,356
+	I -I	Lead Finish	+M	-M	Ni/Pd/Au plating	0.0092	mg	+C -	Св	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.0083	mg			10,372
								+C -	C Supplier		+S	-S	Palladium (Pd)	7440-05-3		0.0008	mg			943
											+S	-S	Gold (Au)	7440-57-5		0.0001	mg			188
+	I -I	Bonding Wire	+M	-M	Gold Wire	0.015	mg	+C -	Supplier		+S	-S	Gold (Au)	7440-57-5		0.015	mg			18,802
+	1 -1	Molding Compound	+M	-м	EME-G770HCD	0.35654	5mg	+C -(	Supplier		+S	-s	Silica Fused	60676-86-0		0.3334	mg			417,06
											+S	-s	Epoxy Resin	Proprietary		0.0107	mg			13,382
											+S	-s	Phenol Resin	Proprietary		0.0107	mg			13,382
											+S	-s	Carbon Black	1333-86-4		0.0018	mg			2,230
+	I -I	Die Attached Epoxy	+M	-M	8200TI	0.02353	1mg	+C -	Supplier		+S	-s	Silver (Ag)	7440-22-4		0.0188	mg			23,551
						•					+S	-s	Acrylate resins	Proprietary		0.0047	mg			5,888